



MATERIALS:

HOUSING: HI-TEMP. PLASTIC (UL 94V-0), BLACK
 TERMINAL: PHOSPHOR BRONZE, GOLD PLATED OVER ALL
 SHELL: STAINLESS STEEL SMT AREA GOLD PLATED

SPECIFICATION:

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -25°C~+85°C

SECTION A-A

RECOMMENDED P.C.B LAYOUT
 COMPONENT SIDE (TOLERANCE ±0.05)

RoHS Compliant		玄茂科技股份有限公司 HSIUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准		TOLERANCE UNLESS OTHERWISE SPECIFIED .X± 0.30 X*± 3° .XX± 0.20 .X*± 3° .XXX± 0.10 .XX*± 3°	PART NAME 品名 MICRO SIM CARD CONNECTOR 6PIN SMT 90° TYPE H=2.4mm W/O LOCATING PEG & W/O SWITCH GOLD FLASH PLATING REEL PACKING BLACK COLOR ROHS
DWG. 製圖 Betty	SCALE 比例 參考	UNIT 單位 MM	SIZE. 紙張尺寸 A4
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